

HSF

NOTES:

Current Rating: 1.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: -40℃ to +105℃

Contact Material: Phosphor Bronze
Contact plating: Au over Ni
Insulator Material: PA9T+30%GF UL94V-0

Ordering Information

2335-2 XX M XX CUN X 1

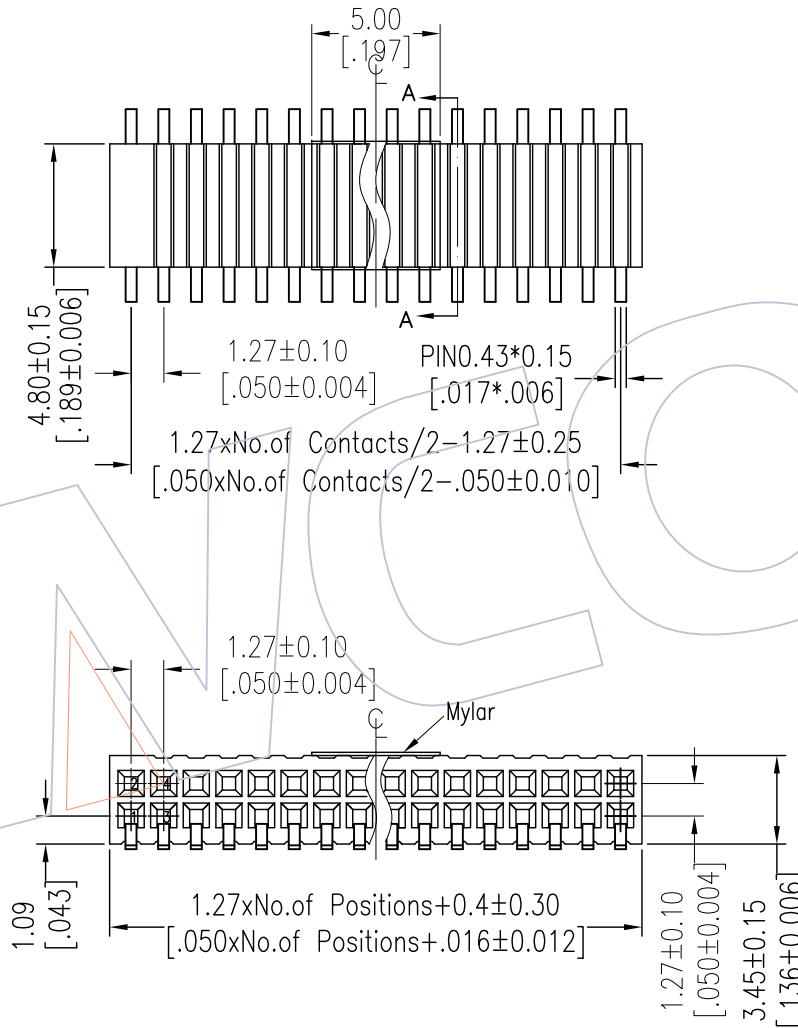
No. of Pins per
Row: 02~50Pin

Contact Plating:
G0=Gold Flash
G3=10μ"Gold
G4=15μ"Gold
G5=30μ"Gold
S0=Gold Flash/Tin
S3=10μ"Gold/Tin
S4=15μ"Gold/Tin
S5=30μ"Gold/Tin
SN=Tin

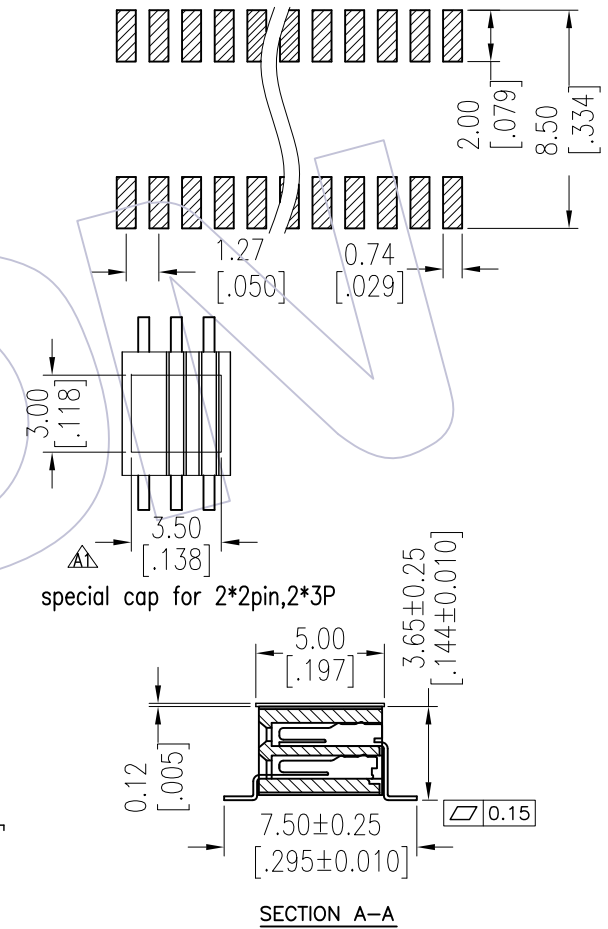
Packing:
T=Tube
P=Tube+CAP&Mylar
R=Reel+CAP&Mylar



Item	Pitch	Mating
Standard	1.27	1310/1315/1320
Alternate		



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



				OPERATION		DRAW	DATE	SCALE	FIT	PART NO.				
				x.x	±0.40		wang	2014/08/08	UNIT	mm	2335-2XXMXXCUNX1			
A1	2014/08/08	Modify Mylar	-----	x.xx	±0.25	CHECK	DATE	SIZE	A4	TITLE:				
A0	2012/07/07	NEW	-----	x.xxx	±0.15			FH1.27mm DUAL SIDE INSERT SMT		SHEET	1/1			
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle	± 3'	APPROVE	DATE	PROJ.				Customer NO.		
				DIM	TOL									